

GD2X30MPS06N

650V 60A SiC Schottky MPS™ Diode



Silicon Carbide Schottky Diode

V _{RRM}	=	650 V
I _F (T _C = 116°C)	=	60 A *
Q _C	=	92 nC *

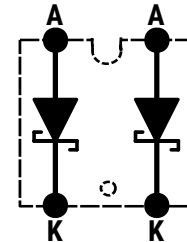
Features

- Gen4 Thin Chip Technology for Low V_F
- Superior Power Efficiency
- Superior Figure of Merit Q_C/I_F
- Enhanced Surge Current Robustness
- Low Thermal Resistance
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness

Package



SOT-227



Advantages

- Optimal Price Performance
- Improved System Efficiency
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- High System Reliability
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

Applications

- Power Factor Correction (PFC)
- Electric Vehicles and Battery Chargers
- Solar Inverters
- High Frequency Converters
- Switched Mode Power Supply (SMPS)
- Motor Drives
- Anti-Parallel / Free-Wheeling Diode
- Induction Heating & Welding

Absolute Maximum Ratings (At T_C = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage (Per Leg)	V _{RRM}		650	V	
Continuous Forward Current (Per Leg / Per Device)	I _F	T _C = 75°C, D = 1	42 / 84	A	Fig. 4
		T _C = 100°C, D = 1	35 / 70		
		T _C = 116°C, D = 1	30 / 60		
Non-Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	I _{F,SM}	T _C = 25°C, t _p = 10 ms	210	A	
		T _C = 150°C, t _p = 10 ms	168		
Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	I _{F,RM}	T _C = 25°C, t _p = 10 ms	126	A	
		T _C = 150°C, t _p = 10 ms	89		
Non-Repetitive Peak Forward Surge Current (Per Leg)	I _{F,MAX}	T _C = 25°C, t _p = 10 μs	1050	A	
i ² t Value (Per Leg)	∫i ² dt	T _C = 25°C, t _p = 10 ms	220	A ² s	
Non-Repetitive Avalanche Energy (Per Leg)	E _{AS}	L = 0.6 mH, I _{AS} = 30 A	276	mJ	
Diode Ruggedness (Per Leg)	dV/dt	V _R = 0 ~ 520 V	200	V/ns	
Power Dissipation (Per Leg / Per Device)	P _{TOT}	T _C = 25°C	136 / 272	W	Fig. 3
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C	

* Per Device

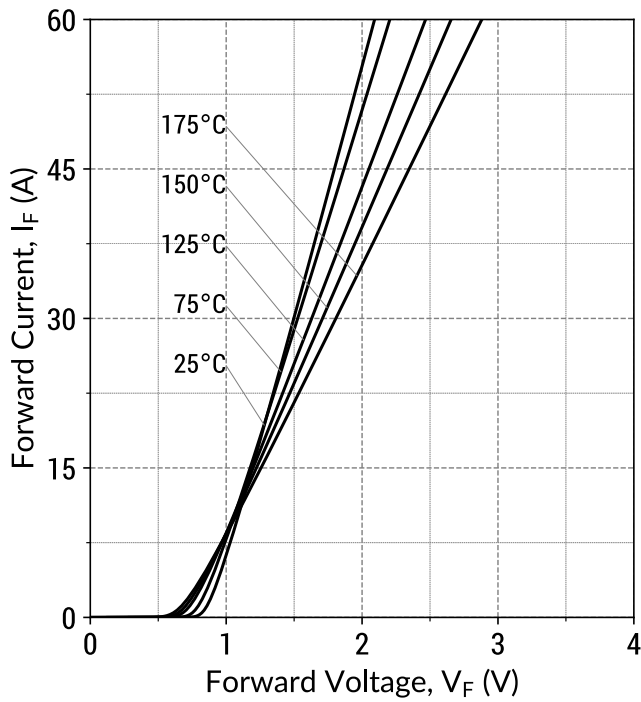
Electrical Characteristics (Per Leg)

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Diode Forward Voltage	V_F	$I_F = 30\text{ A}, T_j = 25^\circ\text{C}$		1.5	1.8	V	Fig. 1
		$I_F = 30\text{ A}, T_j = 175^\circ\text{C}$		1.8			
Reverse Current	I_R	$V_R = 650\text{ V}, T_j = 25^\circ\text{C}$		1	5	μA	Fig. 2
		$V_R = 650\text{ V}, T_j = 175^\circ\text{C}$		6			
Total Capacitive Charge	Q_C	$I_F \leq I_{F,MAX}$ $df/dt = 200\text{ A}/\mu\text{s}$	$V_R = 200\text{ V}$	31		nC	Fig. 7
			$V_R = 400\text{ V}$	46			
Switching Time	t_s		$V_R = 200\text{ V}$	< 10		ns	
			$V_R = 400\text{ V}$				
Total Capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}$		735		pF	Fig. 6
		$V_R = 400\text{ V}, f = 1\text{ MHz}$		63			

Thermal/Package Characteristics

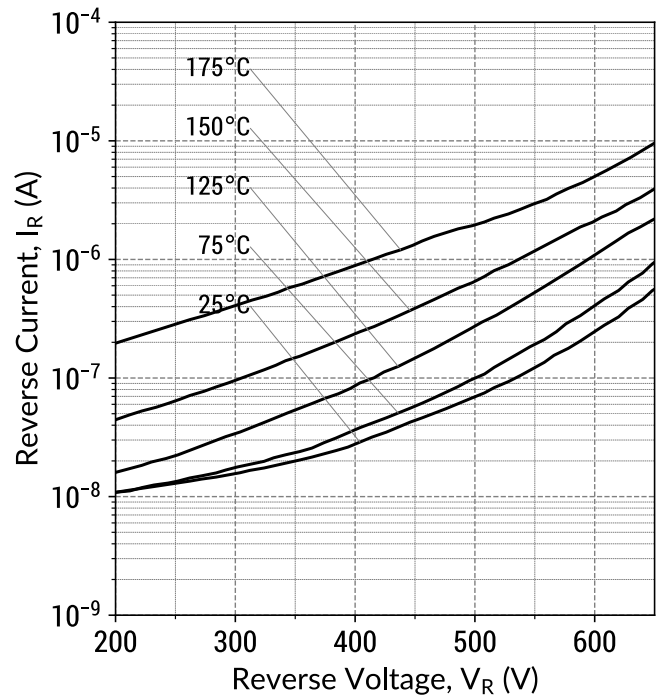
Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Thermal Resistance, Junction - Case (Per Leg)	R_{thJC}			1.1		$^\circ\text{C}/\text{W}$	Fig. 9
Weight	W_T			28.0		g	
Mounting Torque	T_M	Screws to Heatsink			1.5	Nm	
Terminal Connection Torque	T_C	M4 Screws			1.3	Nm	
Isolation Voltage(RMS)	V_{iso}	$t = 1\text{ s (50/60 Hz)}$		3000		V	
		$t = 60\text{ s (50/60 Hz)}$		2500			
Creepage Distance on Surface	d_{ctt}	Terminal to Terminal		10.5		mm	
	d_{ctb}	Terminal to Backside		8.5			
Striking Distance Through Air	d_{stt}	Terminal to Terminal		3.2		mm	
	d_{stb}	Terminal to Backside		6.8			

Figure 1: Typical Forward Characteristics (Per Leg)



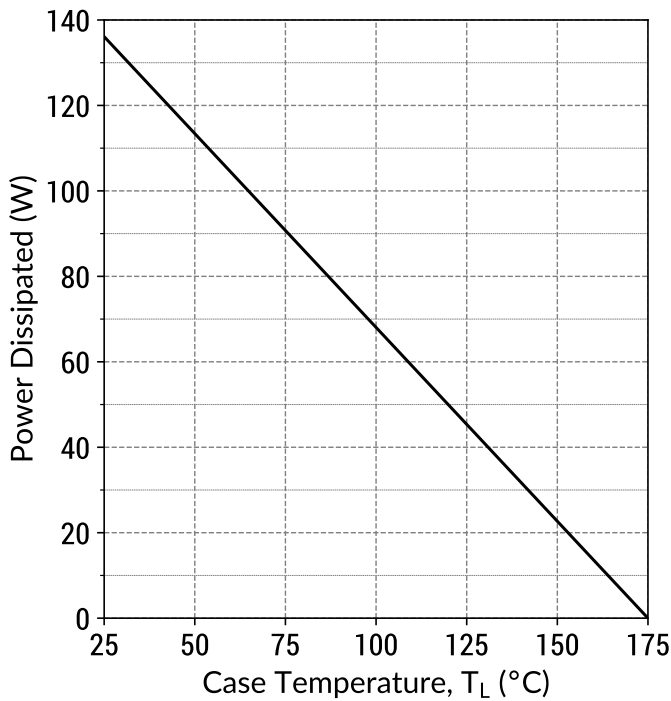
$$I_F = f(V_F, T_j); t_P = 250 \mu s$$

Figure 2: Typical Reverse Characteristics (Per Leg)



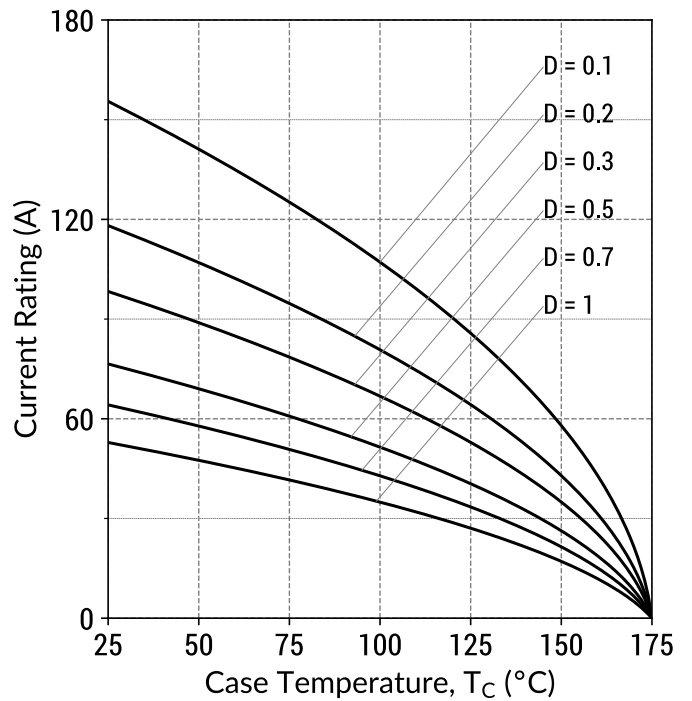
$$I_R = f(V_R, T_j)$$

Figure 3: Power Derating Curves (Per Leg)



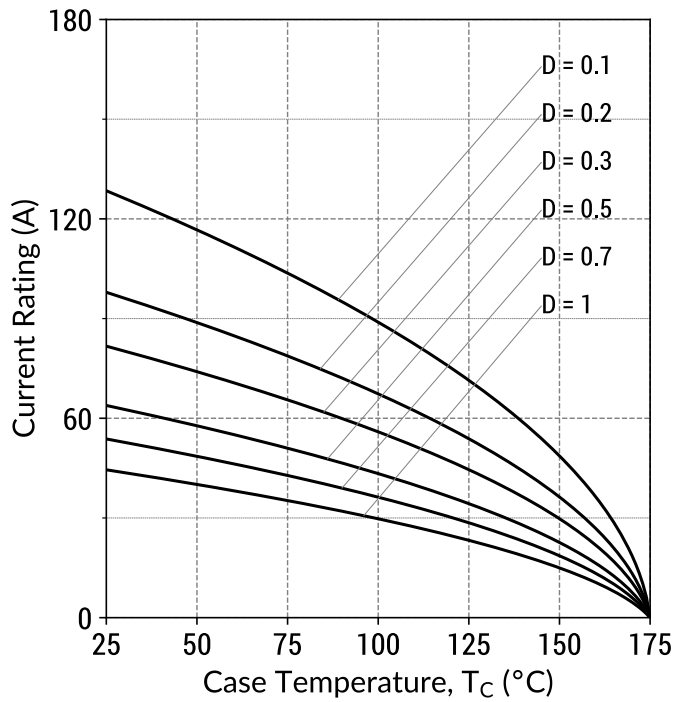
$$P_{TOT} = f(T_C); T_j = 175^\circ C$$

Figure 4: Current Derating Curves (Typical V_F) (Per Leg)



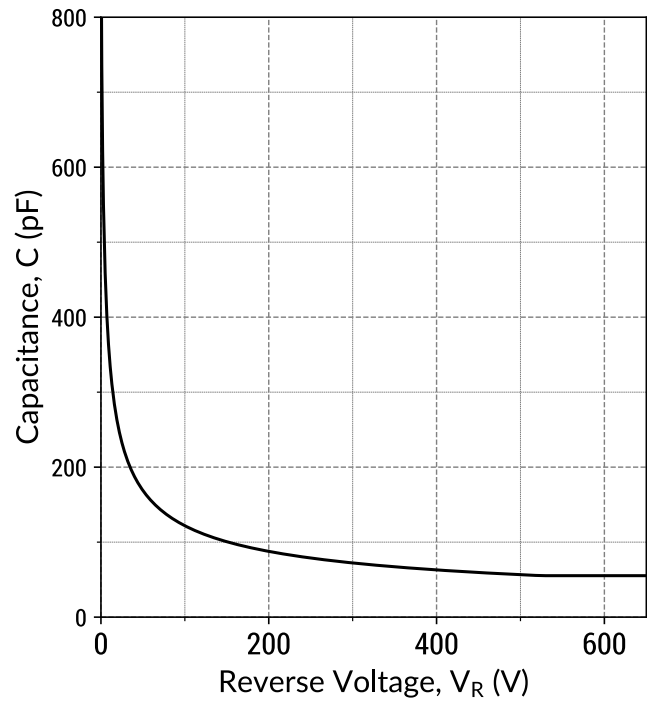
$$I_F = f(T_C); D = t_P/T; T_j \leq 175^\circ C; f_{sw} > 10 kHz$$

Figure 5: Current Derating Curves (Maximum V_F) (Per Leg)



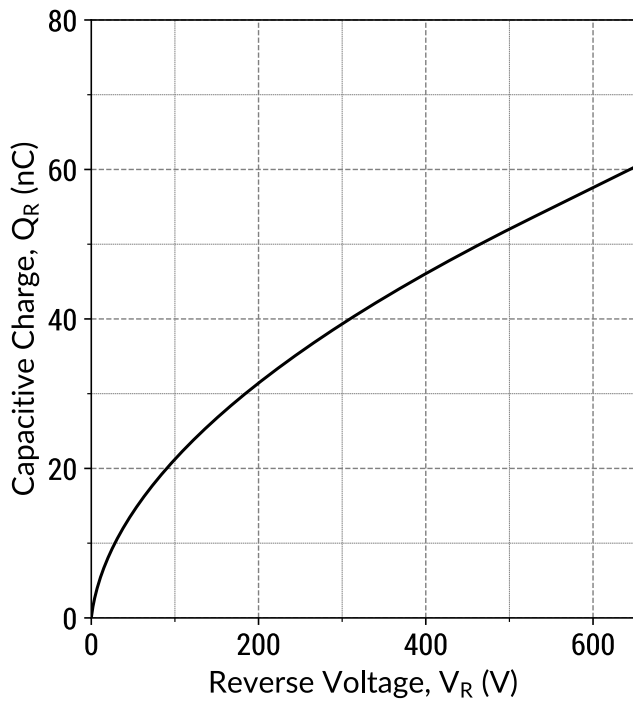
$I_F = f(T_C)$; $D = t_P/T$; $T_j \leq 175^\circ\text{C}$; $f_{SW} > 10\text{kHz}$

Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics (Per Leg)



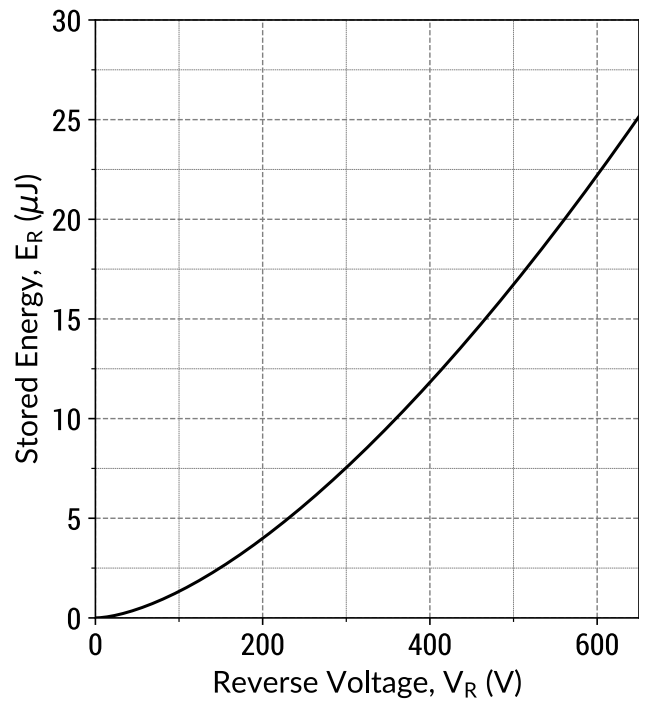
$C = f(V_R)$; $f = 1\text{MHz}$

Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics (Per Leg)



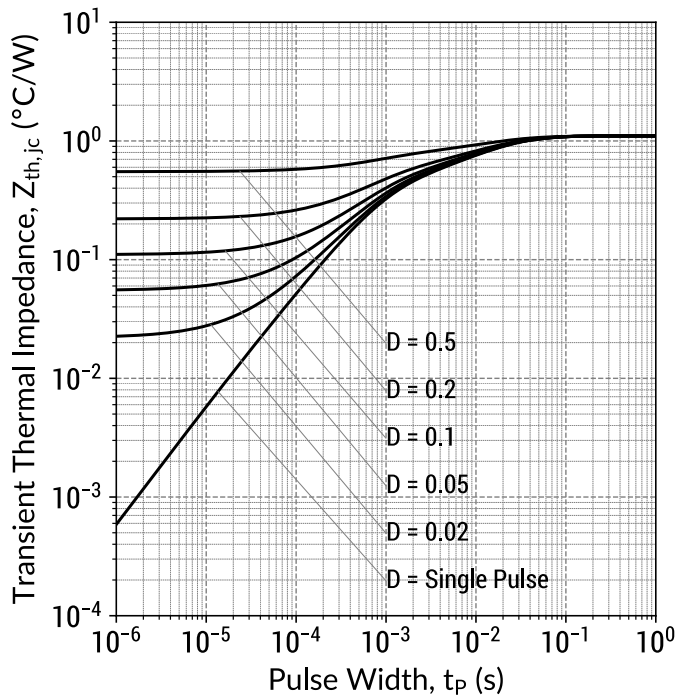
$Q_C = f(V_R)$; $f = 1\text{MHz}$

Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics (Per Leg)



$E_C = f(V_R)$; $f = 1\text{MHz}$

Figure 9: Transient Thermal Impedance (Per Leg)



$$Z_{th,jc} = f(t_p, D); D = t_p/T$$

Figure 10: Forward Curve Model (Per Leg)



$$I_F = f(V_F, T_j)$$

Forward Curve Model Equation:

$$I_F = (V_F - V_{BI})/R_{DIFF} \text{ (A)}$$

Built-In Voltage (V_{BI}):

$$V_{BI}(T_j) = m \times T_j + n \text{ (V)}$$

$$m = -0.00115 \text{ (V/°C)}$$

$$n = 9.31e-01 \text{ (V)}$$

Differential Resistance (R_{DIFF}):

$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c \text{ (}\Omega\text{)}$$

$$a = 5.07e-07 \text{ (}\Omega\text{/°C}^2\text{)}$$

$$b = 5.5e-06 \text{ (}\Omega\text{/°C)}$$

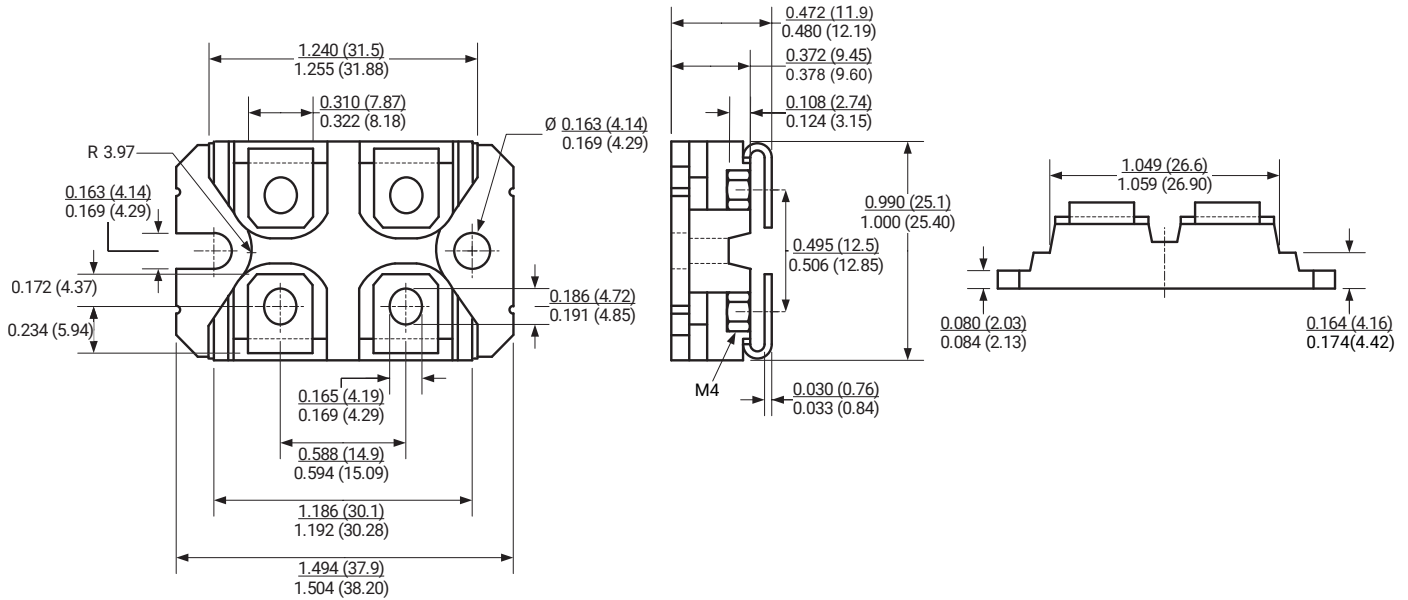
$$c = 0.0194 \text{ (}\Omega\text{)}$$

Forward Power Loss Equation:

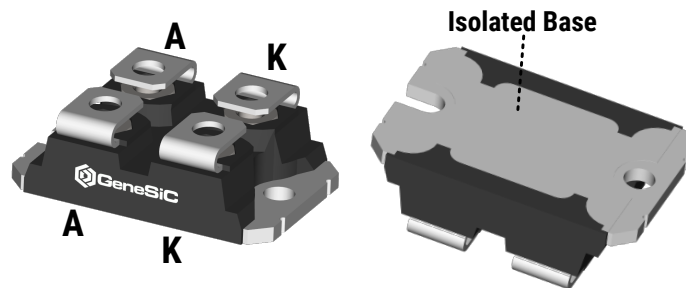
$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$

Package Dimensions

SOT-227 Package Outline



Package View



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.

Compliance

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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Revision History

Date	Revision	Comments	Supersedes
Jul. 27, 2020	Rev 1	Initial Release	



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